

100V N-Ch Power MOSFET

V_{DS}	100	V
$R_{DS(on),typ}$	$V_{GS}=10V$	16.5
$R_{DS(on),typ}$	$V_{GS}=4.5V$	20.6
I_D	8	A

Part Number	Package	Marking
HGS220N10SL	SOIC-8	GS220N10SL

Absolute Maximum Ratings at T_J

Parameter	Symbol	Conditions	Value	Unit
Continuous Drain Current	I_D	T_C	8	A
		T_C	6.2	
Drain to Source Voltage	V_{DS}	-	100	V
Gate to Source Voltage	V_{GS}	-	20	V
Pulsed Drain Current	I_{DM}	-	34	A
Avalanche Energy, Single Pulse	E_{AS}	$L=0.1mH, T_C$	12	mJ
Power Dissipation	P_D	T_C	3.1	W
Operating and Storage Temperature	T_J, T_{stg}	-	-55 to 150	

Absolute Maximum Ratings

Parameter	Symbol	Max	Unit	
Thermal Resistance Junction-Lead	R_{JL}	25		
Thermal Resistance Junction-Ambient (steady state)		40		
		75		

Electrical Characteristics at T_J

Static Characteristics

Parameter	Symbol	Conditions	Value			Unit
			min	typ	max	
Drain to Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=250\text{ A}$	100	-	-	V
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{GS}=V_{DS}, I_D=250\text{ A}$	1.4	2.0	2.4	
Zero Gate Voltage Drain Current	I_{DSS}	$V_{GS}=0V, V_{DS}=100V, T_J$	-	-	1	A
		$V_{GS}=0V, V_{DS}=100V, T_J$	-	-	100	
Gate to Source Leakage Current	I_{GSS}	$V_{GS} = 0V$	-	-	100	nA
Drain to Source on Resistance	$R_{DS(\text{on})}$	$V_{GS}=10V, I_D=8A$	-	16.5	22	m
		$V_{GS}=4.5V, I_D=6A$	-	20.6	26	
Transconductance	g_{fs}	$V_{DS}=5V, I_D=8A$	-	32	-	S
Gate Resistance	R_G	$V_{GS}=0V, V_{DS} \text{ Open}, f=1\text{MHz}$	-	1.5	-	

Dynamic Characteristics

Input Capacitance	C_{iss}	$V_{GS}=0V, V_{DS}=50V, f=1\text{MHz}$	-	1350	-	pF
Output Capacitance	C_{oss}		-	104	-	
Reverse Transfer Capacitance	C_{rss}		-	7	-	
Total Gate Charge	$Q_g(10V)$	$V_{DD}=50V, I_D=8A, V_{GS}=10V$	-	19.9	-	nC
Total Gate Charge	$Q_g(4.5V)$		-	8.5	-	
Gate to Source Charge	Q_{gs}		-	4.8	-	
Gate to Drain (Miller) Charge	Q_{gd}		-	3.0	-	
Turn on Delay Time	$t_{d(\text{on})}$	$V_{DD}=50V, I_D=8A, V_{GS}=10V, R_G=10\Omega$	-	7	-	ns
Rise time	t_r		-	2	-	
Turn off Delay Time	$t_{d(\text{off})}$		-	17	-	
Fall Time	t_f		-	2	-	

Reverse Diode Characteristics

Diode Forward Voltage	V_{SD}	$V_{GS}=0V, I_F=8A$	-	0.9	1.2	V
Reverse Recovery Time	t_{rr}	$V_R=50V, I_F=8A, dI_F/dt=500A/\text{s}$	-	21	-	ns
Reverse Recovery Charge	Q_{rr}		-	92	-	nC

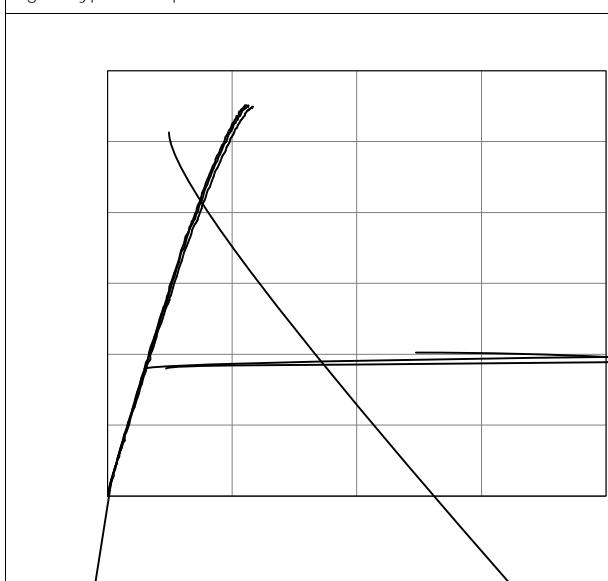
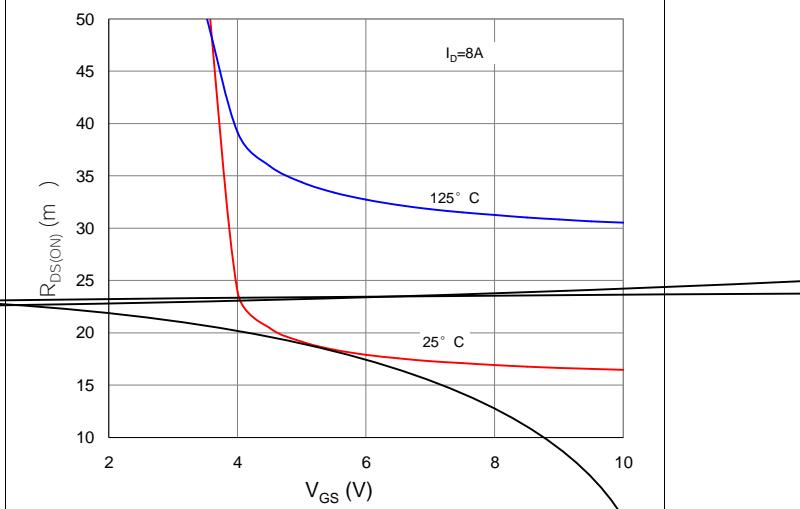
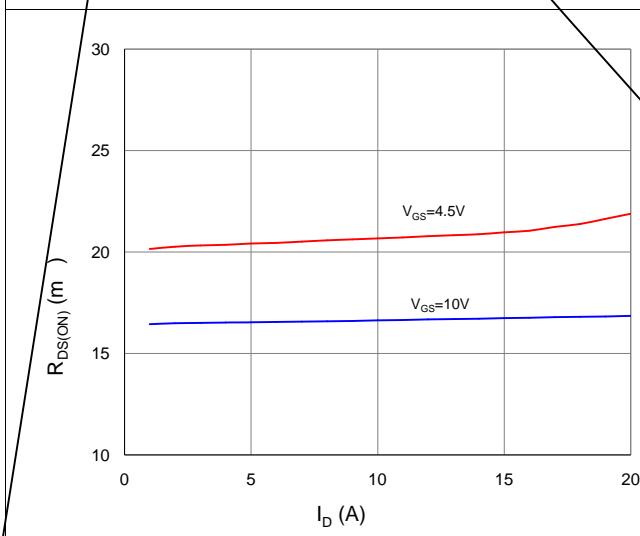
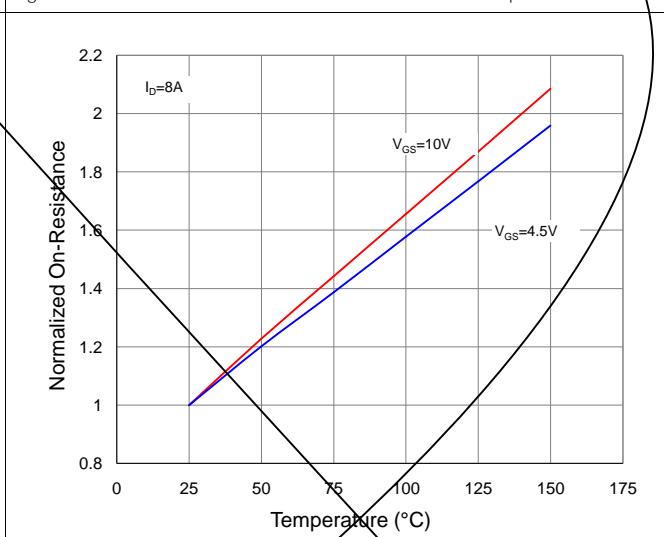
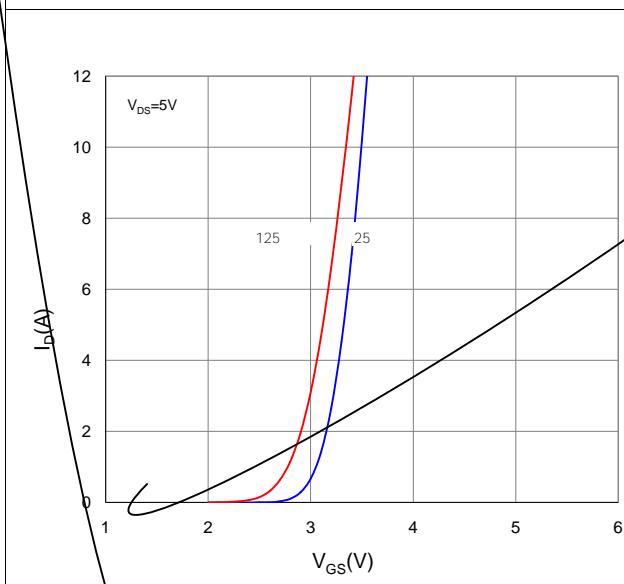
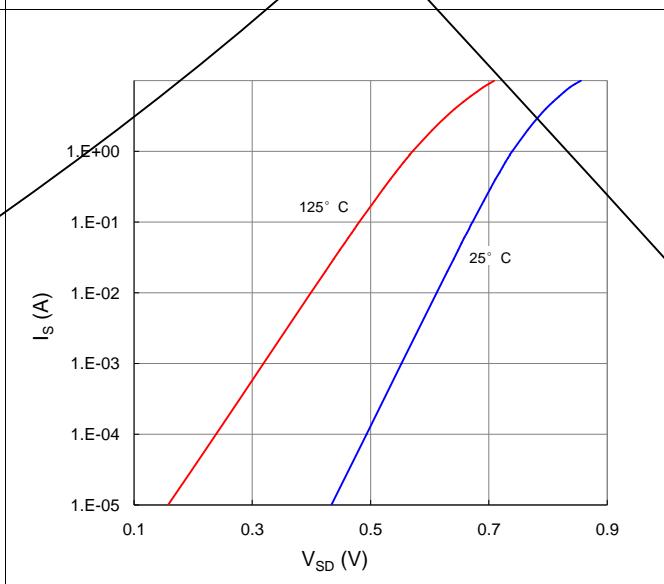
Fig 1. Typical Output Characteristics

Figure 2. On-Resistance vs. Gate-Source Voltage

Figure 3. On-Resistance vs. Drain Current and Gate Voltage

Figure 4. Normalized On-Resistance vs. Junction Temperature

Figure 5. Typical Transfer Characteristics

Figure 6. Typical Source-Drain Diode Forward Voltage


Figure 7. Typical Gate-Charge vs. Gate-to-Source Voltage

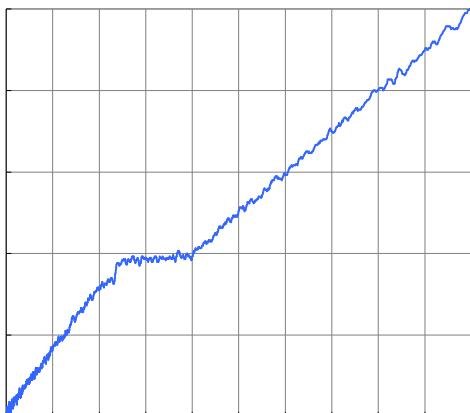
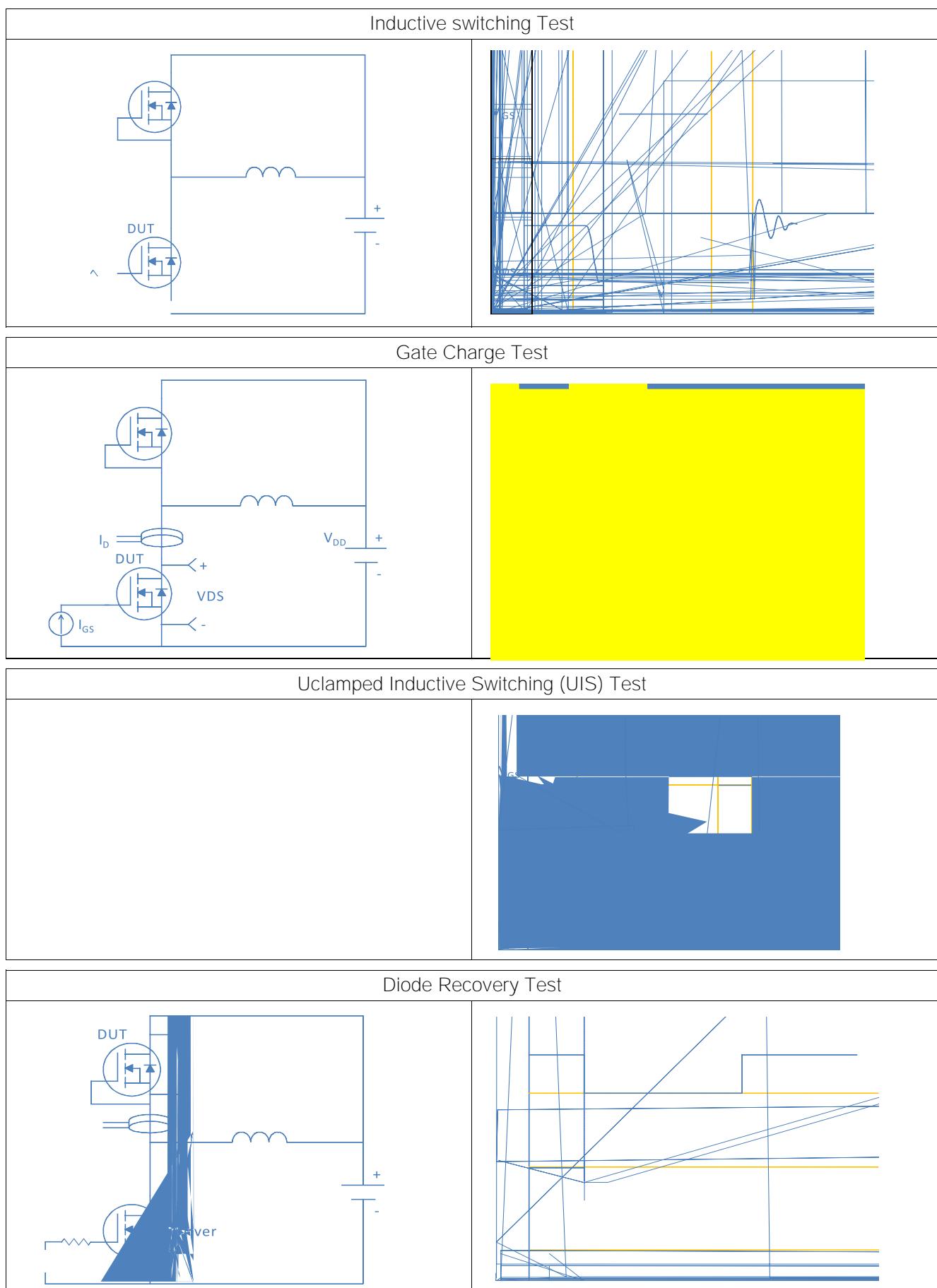


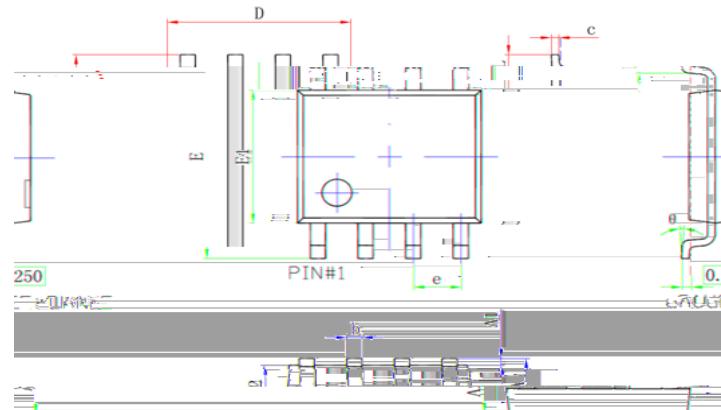
Figure 8. Typical Capacitance vs. Drain-to-Source Voltage

Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs. Case Temperature

Figure 11. Normalized Maximum Transient Thermal Impedance, Junction-to-Ambient



Package Outline
SOIC-8, 8 leads


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.250	1.650	0.049	0.065
b	0.310	0.510	0.012	0.020
c	0.170	0.250	0.007	0.010
D	4.800	5.000	0.189	0.197
e	1.270 (RSC)		0.050 (SRC)	